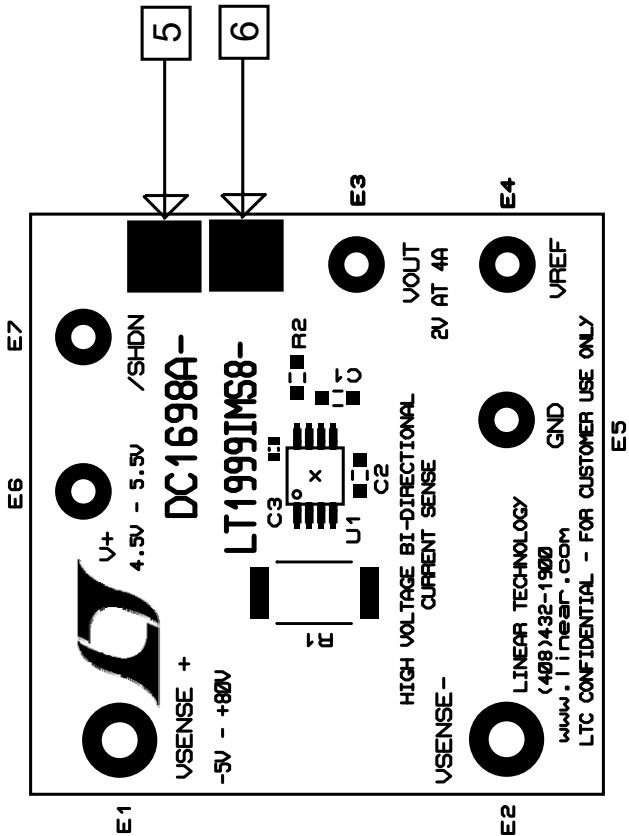


REVISION HISTORY				
ECO	REV	DESCRIPTION	APP. ENG.	DATE
	1	PRODUCTION	CUYLER L.	10/01/2010

NOTES: UNLESS OTHERWISE SPECIFIED.

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610
2. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILLS OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD MAXIMUM SOLDER TEMPERATURE IS 240 DEG. CELCIUS
5. MARK ASSEMBLY TYPE WITH BLACK PERMANENT MARKER WHERE SHOWN
6. MARK IC PART NUMBER WITH BLACK PERMANENT MARKER WHERE SHOWN
7. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD



APPROVALS PCB DES. CL APP ENG CUYLER L.		1630 McCarthy Blvd. Milpitas, CA 95035 PH: (408) 432-1900 www.linear.com LTC CONFIDENTIAL FOR- CUSTOMER USE ONLY	
		LINEAR TECHNOLOGY TITLE: PCB ASSEMBLY DRAWING. HIGH VOLTAGE BI-DIRECTIONAL CURRENT SENSE	
SCALE = NONE		SIZE IC NO LT1999IMS8-10/-20/-50 DEMO CIRCUIT 1698A	REV 1
		FILENAME: 1698A-1.LYT	
		SH 1 OF 1	